Data sheet acquired from Harris Semiconductor

# CD54/74AC283, CD54/74ACT283

August 1998 - Revised May 2000

# 4-Bit Binary Fill Adder With Fast Carry

### **Features**

- · Buffered Inputs
- Exceeds 2kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Speed of Bipolar FAST™/AS/S with Significantly Reduced Power Consumption
- Balanced Propagation Delays
- AC Types Feature 1.5V to 5.5V Operation and Balanced Noise Immunity at 30% of the Supply
- ±24mA Output Drive Current
  - Fanout to 15 FAST™ ICs
  - Drives  $50\Omega$  Transmission Lines

## Description

The 'AC283 and 'ACT283 4-bit binary adders with fast carry that utilize Advanced CMOS Logic technology. These devices add two 4-bit binary numbers and generate a carry-out bit if the sum exceeds 15.

Because of the symmetry of the add function, this device can be used with either all active-HIGH operands (positive logic) or with all active-LOW operands (negative logic). When using positive logic, the carry-in input must be tied LOW if there is no carry-in.

# **Ordering Information**

| PART<br>NUMBER | TEMP.<br>RANGE ( <sup>O</sup> C)    | PACKAGE      |
|----------------|-------------------------------------|--------------|
| CD54AC283F3A   | -55 to 125                          | 16 Ld CERDIP |
| CD74AC283E     | 0 to 70°C, -40 to 85,<br>-55 to 125 | 16 Ld PDIP   |
| CD74AC283M     | 0 to 70°C, -40 to 85,<br>-55 to 125 | 16 Ld SOIC   |
| CD54ACT283F3A  | -55 to 125                          | 16 Ld CERDIP |
| CD74ACT283E    | 0 to 70°C, -40 to 85,<br>-55 to 125 | 16 Ld PDIP   |
| CD74ACT283M    | 0 to 70°C, -40 to 85,<br>-55 to 125 | 16 Ld SOIC   |

#### NOTES:

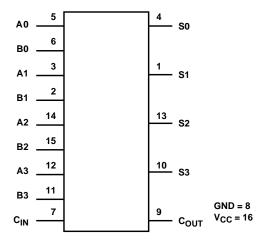
- 1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
- Wafer and die for this part number is available which meets all electrical specifications. Please contact your local TI sales office or customer service for ordering information.

### **Pinout**

#### (CERDIP) CD74AC283, CD74ACT283 (PDIP, SOIC) TOP VIEW 16 V<sub>CC</sub> S1 1 15 B2 B1 2 14 A2 A1 3 S0 4 13 S2 12 A3 A0 5 B0 6 11 B3 10 S3 CIN 7 9 C<sub>OUT</sub> GND 8

CD54AC283, CD54ACT283

## Functional Diagram



## CD54/74AC283, CD54/74ACT283

### **Absolute Maximum Ratings**

| DC Supply Voltage, V <sub>CC</sub> 0.5V to 6V   |
|---|
| DC Input Diode Current, I <sub>IK</sub>   |
| For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$ ±20mA  |
| DC Output Diode Current, I <sub>OK</sub>  |
| For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$  |
| DC Output Source or Sink Current per Output Pin, IO                                       |
| For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$  |
| DC V <sub>CC</sub> or Ground Current, I <sub>CC or</sub> I <sub>GND</sub> (Note 3) ±100mA |

### **Thermal Information**

| Thermal Impedance (Typical, Note 5)            | $\theta_{JA}$ (oC/W)  |
|--|-----------------------|
| PDIP Package                                   | . 67 <sup>0</sup> C/W |
| SOIC Package                                   | . 73 <sup>0</sup> C/W |
| Maximum Junction Temperature (Plastic Package) | 150 <sup>0</sup> C    |
| Maximum Storage Temperature Range              | 65°C to 150°C         |
| Maximum Lead Temperature (Soldering 10s)       | 300°C                 |
|  |                       |

## **Operating Conditions**

| Temperature Range, T <sub>A</sub> 55°C to 125°C             |
|---|
| Supply Voltage Range, V <sub>CC</sub> (Note 4)              |
| AC Types1.5V to 5.5V  |
| ACT Types   |
| DC Input or Output Voltage, V <sub>I</sub> , V <sub>O</sub> |
| Input Rise and Fall Slew Rate, dt/dv                        |
| AC Types, 1.5V to 3V 50ns (Max)                             |
| AC Types, 3.6V to 5.5V                                      |
| ACT Types, 4.5V to 5.5V                                     |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTES:

- 3. For up to 4 outputs per device, add  $\pm 25 \text{mA}$  for each additional output.
- 4. Unless otherwise specified, all voltages are referenced to ground.
- 5. The package thermal impedance is calculated in accordance with JESD 51.

### **DC Electrical Specifications**

|                           |                 | TEST<br>CONDITIONS<br>V <sub>I</sub> (V) I <sub>O</sub> (mA) |                    | v <sub>cc</sub> | 25°C |      | -40°C TO<br>85°C |      | -55°C TO<br>125°C |      |       |
|---------------------------|-----------------|--|--------------------|-----------------|------|------|------------------|------|-------------------|------|-------|
| PARAMETER                 | SYMBOL          |  |                    | (V)             | MIN  | MAX  | MIN              | MAX  | MIN               | MAX  | UNITS |
| AC TYPES                  |                 |  |                    |                 |      |      |                  |      |                   |      |       |
| High Level Input Voltage  | V <sub>IH</sub> | -  | -                  | 1.5             | 1.2  | -    | 1.2              | -    | 1.2               | -    | V     |
|                           |                 |  |                    | 3               | 2.1  | -    | 2.1              | -    | 2.1               | -    | V     |
|                           |                 |  |                    | 5.5             | 3.85 | -    | 3.85             | -    | 3.85              | -    | V     |
| Low Level Input Voltage   | V <sub>IL</sub> | -  | -                  | 1.5             | -    | 0.3  | -                | 0.3  | -                 | 0.3  | V     |
|                           |                 |  |                    | 3               | -    | 0.9  | -                | 0.9  | -                 | 0.9  | V     |
|                           |                 |  |                    | 5.5             | -    | 1.65 | -                | 1.65 | -                 | 1.65 | V     |
| High Level Output Voltage | Voн             | V <sub>IH</sub> or V <sub>IL</sub>                           | -0.05              | 1.5             | 1.4  | -    | 1.4              | -    | 1.4               | -    | V     |
|                           |                 |  | -0.05              | 3               | 2.9  | -    | 2.9              | -    | 2.9               | -    | V     |
|                           |                 |  | -0.05              | 4.5             | 4.4  | -    | 4.4              | -    | 4.4               | -    | V     |
|                           |                 |  | -4                 | 3               | 2.58 | -    | 2.48             | -    | 2.4               | -    | V     |
|                           |                 |  | -24                | 4.5             | 3.94 | -    | 3.8              | -    | 3.7               | -    | V     |
|                           |                 |  | -75<br>(Note 6, 7) | 5.5             | -    | -    | 3.85             | -    | -                 | -    | V     |
|                           |                 |  | -50<br>(Note 6, 7) | 5.5             | -    | -    | -                | -    | 3.85              | -    | V     |

# CD54/74AC283, CD54/74ACT283

## DC Electrical Specifications (Continued)

|   |                  |                                    | ST<br>ITIONS        | v <sub>cc</sub> | 25   | °C   |      | C TO<br>°C |      | C TO<br>5°C |       |
|---|------------------|------------------------------------|---------------------|-----------------|------|------|------|------------|------|-------------|-------|
| PARAMETER   | SYMBOL           | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) | (V)             | MIN  | MAX  | MIN  | MAX        | MIN  | MAX         | UNITS |
| Low Level Output Voltage  | $V_{OL}$         | V <sub>IH</sub> or V <sub>IL</sub> | 0.05                | 1.5             | -    | 0.1  | -    | 0.1        | -    | 0.1         | V     |
|   |                  |                                    | 0.05                | 3               | -    | 0.1  | -    | 0.1        | -    | 0.1         | V     |
|   |                  |                                    | 0.05                | 4.5             | -    | 0.1  | -    | 0.1        | -    | 0.1         | ٧     |
|   |                  |                                    | 12                  | 3               | -    | 0.36 | -    | 0.44       | -    | 0.5         | V     |
|   |                  |                                    | 24                  | 4.5             | -    | 0.36 | -    | 0.44       | -    | 0.5         | V     |
|   |                  |                                    | 75<br>(Note 6, 7)   | 5.5             | -    | -    | -    | 1.65       | -    | -           | V     |
|   |                  |                                    | 50<br>(Note 6, 7)   | 5.5             | -    | -    | -    | -          | -    | 1.65        | V     |
| Input Leakage Current   | IĮ               | V <sub>CC</sub> or<br>GND          | -                   | 5.5             | -    | ±0.1 | -    | ±1         | -    | ±1          | μА    |
| Quiescent Supply Current<br>MSI   | I <sub>CC</sub>  | V <sub>CC</sub> or<br>GND          | 0                   | 5.5             | -    | 8    | -    | 80         | -    | 160         | μА    |
| ACT TYPES   |                  |                                    |                     |                 |      |      |      |            |      |             |       |
| High Level Input Voltage  | V <sub>IH</sub>  | -                                  | -                   | 4.5 to<br>5.5   | 2    | -    | 2    | -          | 2    | -           | V     |
| Low Level Input Voltage   | V <sub>IL</sub>  | -                                  | -                   | 4.5 to<br>5.5   | -    | 0.8  | -    | 0.8        | -    | 0.8         | V     |
| High Level Output Voltage   | V <sub>OH</sub>  | V <sub>IH</sub> or V <sub>IL</sub> | -0.05               | 4.5             | 4.4  | -    | 4.4  | -          | 4.4  | -           | V     |
|   |                  |                                    | -24                 | 4.5             | 3.94 | -    | 3.8  | -          | 3.7  | -           | V     |
|   |                  |                                    | -75<br>(Note 6, 7)  | 5.5             | -    | -    | 3.85 | -          | -    | -           | V     |
|   |                  |                                    | -50<br>(Note 6, 7)  | 5.5             | -    | -    | -    | -          | 3.85 | -           | V     |
| Low Level Output Voltage  | $V_{OL}$         | V <sub>IH</sub> or V <sub>IL</sub> | 0.05                | 4.5             | -    | 0.1  | -    | 0.1        | -    | 0.1         | V     |
|   |                  |                                    | 24                  | 4.5             | -    | 0.36 | -    | 0.44       | -    | 0.5         | V     |
|   |                  |                                    | 75<br>(Note 6, 7)   | 5.5             | -    | -    | -    | 1.65       | -    | -           | V     |
|   |                  |                                    | 50<br>(Note 6, 7)   | 5.5             | -    | -    | -    | -          | -    | 1.65        | V     |
| Input Leakage Current   | IĮ               | V <sub>CC</sub> or<br>GND          | -                   | 5.5             | -    | ±0.1 | -    | ±1         | -    | ±1          | μА    |
| Quiescent Supply Current<br>MSI   | Icc              | V <sub>CC</sub> or<br>GND          | 0                   | 5.5             | -    | 8    | -    | 80         | -    | 160         | μА    |
| Additional Supply Current per<br>Input Pin TTL Inputs High<br>1 Unit Load | Δl <sub>CC</sub> | V <sub>CC</sub><br>-2.1            | -                   | 4.5 to<br>5.5   | -    | 2.4  | -    | 2.8        | -    | 3           | mA    |

### NOTES:

- 6. Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.
- 7. Test verifies a minimum  $50\Omega$  transmission-line-drive capability at  $85^{\circ}$ C,  $75\Omega$  at  $125^{\circ}$ C.

### **ACT Input Load Table**

| INPUT           | UNIT LOAD |
|-----------------|-----------|
| A0, B0, A2, B2  | 1.66      |
| A1, B1          | 1.9       |
| A3, B3          | 1.4       |
| C <sub>IN</sub> | 1.1       |

NOTE: Unit load is  $\Delta I_{CC}$  limit specified in DC Electrical Specifications Table, e.g., 2.4mA max at 25 $^{\rm o}$ C.

## **Switching Specifications** Input $t_r$ , $t_f$ = 3ns, $C_L$ = 50pF (Worst Case)

|  |                                     |                     | -40°C TO 85°C |     | -55  |     |     |      |       |
|--|-------------------------------------|---------------------|---------------|-----|------|-----|-----|------|-------|
| PARAMETER  | SYMBOL                              | V <sub>CC</sub> (V) | MIN           | TYP | MAX  | MIN | TYP | MAX  | UNITS |
| AC TYPES   |                                     |                     |               |     |      |     |     |      |       |
| Propagation Delay,   | t <sub>PLH</sub> , t <sub>PHL</sub> | 1.5                 | -             | -   | 199  | -   | -   | 219  | ns    |
| An or Bn to C <sub>OUT</sub> C <sub>IN</sub> to Sn C <sub>IN</sub> to C <sub>OUT</sub>                             |                                     | 3.3<br>(Note 9)     | 6.3           | -   | 22.4 | 6.2 | -   | 24.6 | ns    |
|  |                                     | 5<br>(Note 10)      | 4.5           | -   | 16   | 4.4 | -   | 17.6 | ns    |
| Propagation Delay,   | t <sub>PLH</sub> , t <sub>PHL</sub> | 1.5                 | -             | -   | 207  | -   | -   | 228  | ns    |
| An or Bn to Sn   |                                     | 3.3                 | 6.6           | -   | 23.2 | 6.4 | -   | 25.5 | ns    |
|  |                                     | 5                   | 4.7           | -   | 16.5 | 4.6 | -   | 18.2 | ns    |
| Input Capacitance  | Cl                                  | -                   | -             | -   | 10   | -   | -   | 10   | pF    |
| Power Dissipation Capacitance  | C <sub>PD</sub><br>(Note 11)        | -                   | -             | 120 | -    | -   | 120 | -    | pF    |
| ACT TYPES  |                                     |                     |               |     |      |     |     | •    |       |
| Propagation Delay,<br>An or Bn to C <sub>OUT</sub><br>C <sub>IN</sub> to Sn<br>C <sub>IN</sub> to C <sub>OUT</sub> | t <sub>PLH</sub> , t <sub>PHL</sub> | 5<br>(Note 10)      | 4.5           | -   | 16   | 2.7 | -   | 17.6 | ns    |
| Propagation Delay,<br>An or Bn to Sn   | t <sub>PLH</sub> , t <sub>PHL</sub> | 5                   | 4.7           | -   | 16.5 | 3.3 | -   | 18.2 | ns    |
| Input Capacitance  | Cl                                  | -                   | -             | -   | 10   | -   | -   | 10   | pF    |
| Power Dissipation Capacitance  | C <sub>PD</sub><br>(Note 11)        | -                   | -             | 120 | -    | -   | 120 | -    | pF    |

#### NOTES:

- 8. Limits tested 100%.
- 9. 3.3V Min is at 3.6V, Max is at 3V.
- 10. 5V Min is at 5.5V, Max is at 4.5V.

11.  $C_{PD}$  is used to determine the dynamic power consumption per function. AC:  $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ ACT:  $P_D = V_{CC}^2 f_i (C_{PD} + C_L) + V_{CC} \Delta I_{CC}$  where  $f_i$  = input frequency,  $C_L$  = output load capacitance,  $V_{CC}$  = supply voltage.

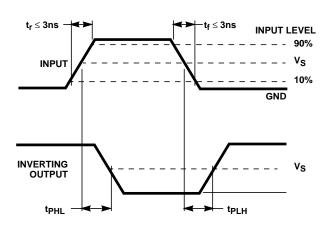
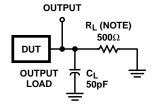


FIGURE 1. PROPAGATION DELAY TIMES



NOTE: For AC Series Only: When  $V_{CC}$  = 1.5V,  $R_L$  = 1k $\Omega$ .

|  | AC                  | ACT                 |
|--|---------------------|---------------------|
| Input Level                              | V <sub>CC</sub>     | 3V                  |
| Input Switching Voltage, V <sub>S</sub>  | 0.5 V <sub>CC</sub> | 1.5V                |
| Output Switching Voltage, V <sub>S</sub> | 0.5 V <sub>CC</sub> | 0.5 V <sub>CC</sub> |

FIGURE 2. PROPAGATION DELAY TIMES





com 1-Jul-2005

#### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup>  | Lead/Ball Finish | MSL Peak Temp (3)   |
|------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|---------------------|
| CD54AC283F3A     | ACTIVE                | CDIP            | J                  | 16   | 1              | TBD                        | Call TI          | Level-NC-NC-NC      |
| CD54ACT283F3A    | ACTIVE                | CDIP            | J                  | 16   | 1              | TBD                        | Call TI          | Level-NC-NC-NC      |
| CD74AC283E       | ACTIVE                | PDIP            | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-NC-NC-NC      |
| CD74AC283EE4     | ACTIVE                | PDIP            | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-NC-NC-NC      |
| CD74AC283M       | ACTIVE                | SOIC            | D                  | 16   | 40             | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-2-250C-1 YEAR |
| CD74AC283M96     | ACTIVE                | SOIC            | D                  | 16   | 2500           | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-2-250C-1 YEAR |
| CD74AC283M96E4   | ACTIVE                | SOIC            | D                  | 16   | 2500           | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-2-250C-1 YEAR |
| CD74AC283ME4     | ACTIVE                | SOIC            | D                  | 16   | 40             | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-2-250C-1 YEAR |
| CD74ACT283E      | ACTIVE                | PDIP            | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-NC-NC-NC      |
| CD74ACT283EE4    | ACTIVE                | PDIP            | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-NC-NC-NC      |
| CD74ACT283M      | ACTIVE                | SOIC            | D                  | 16   | 40             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-2-260C-1YEAR  |
| CD74ACT283M96    | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-2-260C-1YEAR  |
| CD74ACT283M96E4  | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-2-260C-1YEAR  |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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# **PACKAGE OPTION ADDENDUM**

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# 14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



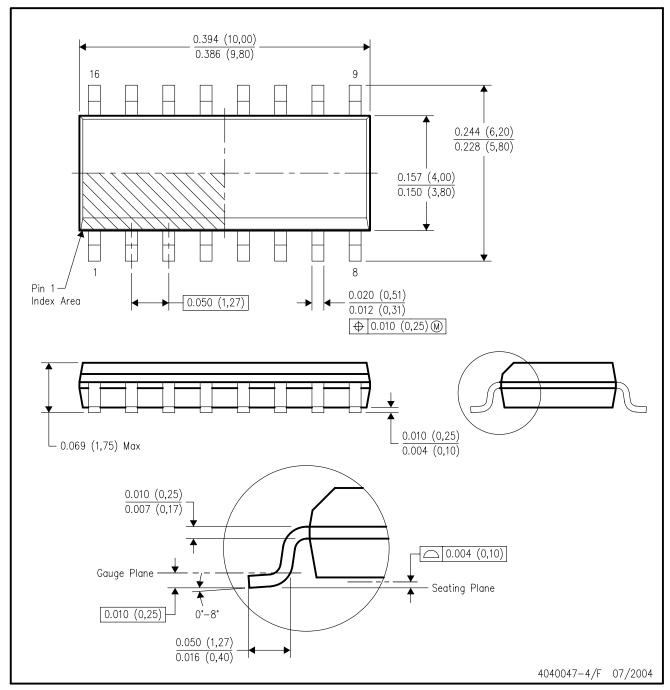
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDSO-G16)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



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